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Application Number	10/571,044
Filing Date	March 3, 2006
First Named Inventor	Takashi Oku
Group Art Unit	2875
Examiner Name	Mary Zettl
Attorney Docket Number	075834.00553

Sheet 1 of 1

U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number	Kind Code ² (if known)			
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FOREIGN PATENT DOCUMENTS

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		Office ³	Number ⁴	Kind Code ⁵ (if known)				
/M.Z./	F1	JP	2001-112777		Olympus Optical Co Ltd	04/24/2001		
/M.Z./	F2	JP	11-038207		Dainippon Printing Co Ltd	02/12/1999		
/M.Z./	F3	JP	08-335044		Dainippon Printing Co Ltd	12/17/1996		
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	F10							

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CORRESPONDING JAPANESE PATENT APPLICATION

JP 2003 - 338308 OA issued on: 2008/2/7

[HQ-CASE]

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